

MECHANICAL DATA

Module dimension

Viewing area

Active area

Pixel size

Pixel pitch

Mounting hole

ITEM

0

STANDARD VALUE

24.9 x 22.95 x 1.65

21.953 x 15.424

19.946 x 13.418

0.186 x 0.188

0.208 x 0.210

n/a

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UNIT

mm

FEATURES

- Type: graphic
- Display format: 96 x 64 dots
- Built-in controller: OLED-0010
- Duty cycle: 1/64
- +3 V power supply
- Interface: SSD1305Z
- Sunlight readable and polarizer optional
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

ABSOLUTE MAXIMUM RATINGS												
ITEM	SYMBOL	STANDAF	UNIT									
	STMBOL	MIN.	MAX.	UNIT								
Supply voltage for logic ⁽¹⁾⁽²⁾	V _{DD}	-0.3	4	V								
Supply voltage for display ⁽¹⁾⁽²⁾	V _{CC}	0	15	v								
Operating temperature	T _{OP}	-40	+80	℃								
Storage temperature	T _{STG}	-40	+80	C								

Notes

- $^{(1)}\,$ All the above voltages are on the basis of "V_{SS} = 0 V".
- (2) When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to section 6 "electrical characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate.

ELECTRICAL CHARACTERISTICS												
ITEM	SYMDOL	CONDITION	ST	ANDARD VA	UE							
	SYMBOL	CONDITION	MIN.	TYP.	MAX.							
Supply voltage for logic	V _{DD}	-	2.8	3.0	3.3							
Supply voltage for display	V _{CC}	-	10	12	14							
Input high voltage	V _{IH}	-	0.8 V _{DD}	-	V _{DDI/O}	v						
Input low voltage	V _{IL}	-	0	-	0.2 V _{DD}	V						
Output high voltage	V _{OH}	-	0.9 V _{DD}	-	V _{DDI/O}							
Output low voltage	V _{OL}	-	0	-	0.1 V _{DD}							
50 % check board operating current	I _{CC}	$V_{CC} = 12 V$	7	8	10	mA						

OPTIONS	OPTIONS														
EMITTING COLOR MOQ															
YELLOW	GREEN	RED	BLUE	WHITE	YELLOW	GREEN	RED	BLUE	WHITE						
-	-	-	Yes	-	-	-	-	Yes	-						

Revision: 10-Aug-16

1 For technical questions, contact: <u>displays@vishay.com</u>

Document Number: 37833



RoHS COMPLIANT

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INTERFA	CE PIN FUN	ICTION									
PIN NO.	SYMBOL	1/0			FUNCTION						
1	NC (GND)	-	The supporting pins car	Reserved pin (supporting pin). The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.							
2	V _{CC}	Р	Power supply for OLED This is the most positiv		ply pin of the chip	. It must be supp	blied externally.				
3	V _{SS}	Р	Ground of logic circuit. This is a ground pin. It external ground.	Ground of logic circuit. This is a ground pin. It also acts as a reference for the logic pins. It must be connected to							
4	V _{DD}	Р	Power supply for logic This is a voltage supply		pe connected to e	xternal source.					
5	V _{DDI/O}	Р	Power supply for interfa It should be match with than V _{DD} .			/ _{DDI/O} must alwa	ys be equal or lower				
6			Communicating protoc These pins are MCU int	terface select	-	-					
	BS1 BS2	I		XX-parallel	80XX-parallel	Serial	l ² C				
7	D32		BS1 0		1	0	1				
7			BS2 1		1	0	0				
8	CS#	I	Chip select. This pin is the chip sel CS# is pulled low.	lect input. Th	e chip is enabled	for MCU comm	unication only when				
9	RES#	I	Power reset for control This pin is reset signal i			lization of the ch	ip is executed.				
10	D / C#	I	Data / command contro This pin is data / comm treated as display data. to the command registe timing characteristics d When the pin is pulled h as data. When it is pulle In I ² C mode, this pin ac	and control p . When the pi er. For detail r liagrams. high and seria ed low, the da	n is pulled low, the elationship to MCl I interface mode is ata at SDIN will be	input at D7 to I J interface signa selected, the da transferred to th	D0 will be transferred ls, please refer to the ata at SDIN is treated				
11	R / W#	I	Read / write selector w This pin is MCU interfa will be used as read / w pull it to "low" for write When 80XX interface r operation is initiated wh	ce input. Whe rrite (R / W#) s mode. node is selee	selection input. Pul	ll this pin to "high be the write (WF	n" for read mode and R#) input. Data write				
12	E / RD#	I	Read / write enable or r This pin is MCU interfar will be used as the enable high and the CS# is pul When connecting to an read operation is initiated	ce input. Whe ble (E) signal. lled low. 180XX-micro	Read / write opera	tion is initiated w receives the rea	rhen this pin is pulled ad (RD#) signal. Data				
13											
14	7										
15	7		Host data input / outpu	t bus.							
16			These pins are 8-bit bi	-directional d							
17	D0 to D7	1/0	bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. When I ² C mode is selected, D2 and D1 should be tired together and serve as SDA _{out} and SDA _{in} in application and D0 is the serial clock input SCL.								
18	7										
19	1										
20	1										
21	IREF	I	Current reference for but This pin is segment current and V _{SS} . Set the current	rent referenc	e pin. A resistor sl	nould be connec	ted between this pin				

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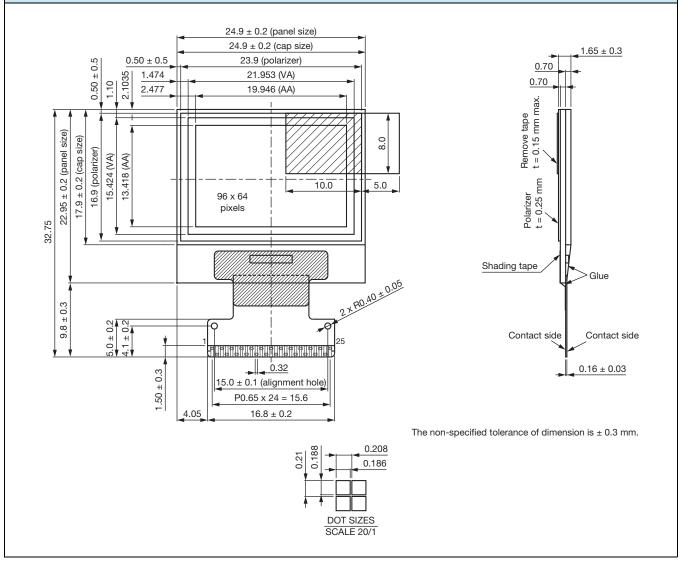


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INTERFA	INTERFACE PIN FUNCTION										
PIN NO.	SYMBOL	1/0	FUNCTION								
22	VCOMH	0	Voltage output high level for COM signal. This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and $V_{\rm SS}$.								
23	V _{CC}	Р	Power supply for OLED panel. This is the most positive voltage supply pin of the chip. It must be supplied externally.								
24	VLSS	Р	Ground of analog circuit. This is an analog ground pin. It should be connected to $V_{\rm SS}$ externally.								
25	NC (GND)	-	Reserved pin (supporting pin). The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.								

DIMENSIONS in millimeters





1.Module Classification Information

<u>OLED</u>	-096	0	064	Α	B	Ρ	Ρ	3	Ν	0	0	000
1	2	3	4	5	6	7	8	9	10	11	12	13

Brand : Vishav Ir	ntertechnology Inc								
Horizontal Format: 96 columns									
Display Type : N \rightarrow Character Type, H \rightarrow Graphic Type, Y \rightarrow TAB Type ,O \rightarrow COG Type									
Series code. A	A : Amber	R : RED							
		C : Full color							
Emitting Color		W : White							
Ū									
	Y : Yellow Green	L : Yellow							
Polarizer	P: With Polarizer; N: Without Pola	arizer							
Display Mode	P : Passive Matrix ; A: Active Matr	ix							
Driver Voltage	3: 3.0 V; 5: 5.0V	3: 3.0 V; 5: 5.0V							
Touch Panel	N : Without touch panel; T: With to	buch panel							
	0:Standard type								
	1. Sunlight Readable type								
Products type	2. Transparent OLED (TOLED)								
	3. Flexible OLED								
	4. OLED for Lighting								
	0 : Standard(A-level)								
	2 : B-level								
Product grades	3 : C-level								
	4 : high class(AA-level)								
	5 : Customer offerings								
Sorial No.	Application serial number(000~ZZZ)								
Serial No.									
	Horizontal Forma Display Type : N Vertical Format: Series code: A Emitting Color Polarizer Display Mode Driver Voltage Touch Panel Products type	Display Type : N→Character Type, H→Graphic TypeVertical Format:64 rows or linesSeries code:AA: AmberB: BlueG : GreenYY : Yellow GreenPolarizerP : With Polarizer; N: Without PolaDisplay ModeP : Passive Matrix ; A: Active MatrDriver Voltage3: 3.0 V; 5: 5.0VTouch PanelN : Without touch panel; T: With toProducts type1. Sunlight Readable type2. Transparent OLED (TOLED)3. Flexible OLED4. OLED for Lighting0 : Standard(A-level)2 : B-level3 : C-level4 : high class(AA-level)5 : Customer offeringsApplication serial number(000~ZZZ)							

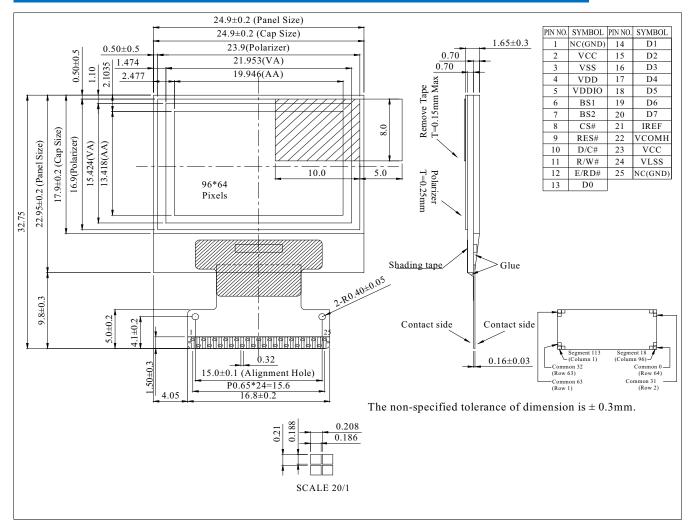


2.General Specification

2.1. Item	Dimension	Unit	
Dot Matrix	96 x 64 Dots	_	
Module dimension	24.9 × 22.95 × 1.65 (mm)	mm	
Active Area	19.946 × 13.418 (mm)	mm	
Pixel Size	0.186 × 0.188 (mm)	mm	
Pixel Pitch	0.208 × 0.21 (mm)	mm	
Display Mode	Passive Matrix		
Display Color	Blue		
Drive Duty	1/64 Duty		
IC	SSD1305Z		

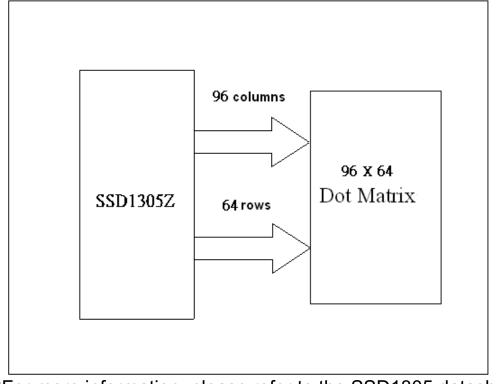


3. Contour Drawing & Block Diagram





VCC Supplied Externally



*For more information, please refer to the SSD1305 datasheet.



4. Interface Pin Function

Pin Number	Symbol	I/O	Function
1.	N.C. (GND)	-	Reserved Pin(Supporting Pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.
2.	VCC	Р	Power Supply for OLED Panel This is the most positive voltage supply pin of the chip.It must be supplied externally.
3.	VSS	Р	Ground of Logic Circuit This is a ground pin. It also acts as a reference for the logic pins. It must be connected to external ground.
4.	VDD	Р	Power Supply for Logic Circuit This is a voltage supply pin. It must be connected to external source.
5.	VDDIO	Р	Power supply for interface logic level. It should be match with MCU interface voltage level. VDDIO must always be equal or lower than VDD.
6.	BS1	I	Communicating Protocol Select These pins are MCU interface selection input. See the following table: 68XX-parallel 80XX-parallel Image: Second Select
7.	BS2		BS1 0 1 0 1 BS2 1 1 0 0
8.	CS#	Ι	Chip Select This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled low.
9.	RES#	Ι	Power Reset for Controller and Driver This pin is reset signal input. When the pin is low, initialization of the chip is executed.
10.	D/C#	Ι	Data/ Command Control This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams. When the pin is pulled high and serial interface mode is selected, the data at SDIN is treated as data. When it is pulled low, the data at SDIN will be transferred to the command register. In I2C mode, this pin acts as SA0 for slave address selection.
11.	R/W#	Ι	Read/ Write Selector Write This pin is MCU interface input. When interfacing to a68XX-series microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it to "Low" for write mode. When 80XXinterface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.
12.	E/RD#	Ι	Read/Write Enable or Read



			This pin is MCU interface input. When interfacing to a68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.
13. 14. 15. 16. 17. 18. 19. 20.	D0~D7	I/O	Host Data In put/ Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. When I2Cmode is selected, D2 & D1 should be tired together and serve as SDAout & SDAin in application and D0 is the serial clock input SCL.
21.	IREF	Ι	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 10µA.
22.	VCOMH	0	Voltage Output High Level for COM Signal This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.
23.	VCC	Р	Power Supply for OLED Panel This is the most positive voltage supply pin of the chip.It must be supplied externally.
24.	VLSS	Р	Ground of Analog Circuit This is an analog ground pin. It should be connected to VSS externally.
25.	N.C. (GND)	-	Reserved Pin(Supporting Pin) The supporting pins can reduce the influences from stresses on the function pins. These pins must be connected to external ground.



5.Absolute Maximum Ratings

Parameter	Symbol	Min	Мах	Unit	Notes
Supply Voltage for Logic	VDD	-0.3	4	V	1, 2
Supply Voltage for Display	VCC	0	15	V	1, 2
Operating Temperature	TOP	-40	+80	°C	-
Storage Temperature	TSTG	-40	+80	°C	-

Note 1: All the above voltages are on the basis of "VSS = 0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent breakage of the module may occur. Also, for normal operations, it is desirable to use this module under the conditions according to Section 6 "Electrical Characteristics". If this module is used beyond these conditions, malfunctioning of the module can occur and the reliability of the module may deteriorate



6.Electrical Characteristics

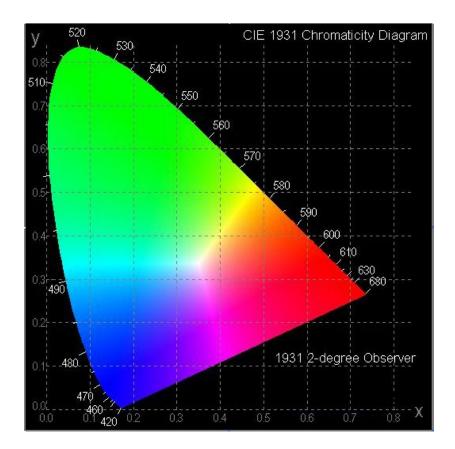
ltem	Symbol	Condition	Min	Тур	Мах	Unit
Supply Voltage for Logic	VDD	—	2.8	3.0	3.3	V
Supply Voltage for Display	VCC	—	10	12	14	V
Input High Volt.	VIH	—	0.8×VDD	—	VDDIO	V
Input Low Volt.	VIL		0	_	0.2×VDD	V
Output High Volt.	VOH	—	0.9×VDD	_	VDDIO	V
Output Low Volt.	VOL		0	_	0.1×VDD	V
50% Check Board operating Current	ICC	VCC=12V	7	8	10	mA





7.Optical Characteristics

Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	(V)θ		160			deg
View Angle	(H)φ		160			deg
Contrast Ratio	CR	Dark	2000:1		_	
Deenenee Time	T rise	—		10		μs
Response Time	T fall	—		10		μs
Display with 50% check Boa		60	80		cd/m2	
CIEx(Blue)	(CIE1931)	0.12	0.16	0.20		
CIEy(Blue)		(CIE1931)	0.19	0.23	0.27	



ΟΙ ΕΠ-006Ο064Δ-RPP3Ν00000





8.OLED Lifetime

ITEM	Conditions	Min	Тур	Remark
Operating Life Time	Ta=25℃ / Initial 50% check board brightness Typical Value	40,000 Hrs	50,000 Hrs	Note

Notes:

- 1. Life time is defined the amount of time when the luminance has decayed to <50% of the initial value.
- 2. This analysis method uses life data obtained under accelerated conditions to extrapolate an estimated probability density function (*pdf*) for the product under normal use conditions.
- 3. Screen saving mode will extend OLED lifetime.



9.Reliability

Content of Reliability Test

Environmenta	I Test		
Test Item	Content of Test	Test Condition	Applicable Standard
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80⊡ 240hrs	
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-40	
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	80 □ 240hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-40 □ 240hrs	
High Temperature/ Humidity Storage	Endurance test applying the high temperature and high humidity storage for a long time.	60□,90%RH 240hrs	
Temperature Cycle	Endurance test applying the low and high temperature cycle. -402580 30min 5min 30min 1 cycle	-40□/80□ 100 cycles	
Mechanical Te	st		
Vibration test	Endurance test applying the vibration during transportation and using.	10~22Hz→1.5mmp-p 22~500Hz→1.5G Total 0.5hr	
Shock test	Constructional and mechanical endurance test applying the shock during transportation.	50G Half sin wave 11 ms 3 times of each direction	
Atmospheric pressure test	Endurance test applying the atmospheric pressure during transportation by air.	115mbar 40hrs	
Others			
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	

*** Supply voltage for OLED system =Operating voltage at $25^\circ\!\mathrm{C}$



Test and measurement conditions

- 1. All measurements shall not be started until the specimens attain to temperature stability. After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure test at 23±5°C; 55±15% RH.
- 2. All-pixels-on is used as operation test pattern.
- 3. The degradation of Polarizer are ignored for High Temperature storage, High Temperature/ Humidity Storage, Temperature Cycle

Evaluation criteria

- 1. The function test is OK.
- 2. No observable defects.
- 3. Luminance: > 50% of initial value.
- 4. Current consumption: within ± 50% of initial value.

APPENDIX:

RESIDUE IMAGE

Because the pixels are lighted in different time, the luminance of active pixels may reduce or differ from inactive pixels. Therefore, the residue image will occur. To avoid the residue image, every pixel needs to be lighted up uniformly.





10.Inspection Specification

NO	Item	Criterion				AQ
01	Electrical Testing	 1.1 Missing vertical, horizontal segment, segment contrast defect. 1.2 Missing character, dot or icon. 1.3 Display malfunction. 1.4 No function or no display. 1.5 Current consumption exceeds product specifications. 1.6 OLED viewing angle defect. 1.7 Mixed product types. 1.8 Contrast defect. 			0.6	
02	Black or white spots on OLED (display only)	 2.1 White and black spots on display ≦0.25mm, r three white or black spots present. 2.2 Densely spaced: No more than two spots or li 3mm. 				
03	OLED black spots, white spots, contamina tion (non-displ ay)	3.1 Round type : following drawing $\Phi=(x + y)/2$	g	SIZE Φ≦0. 0.10<	dense 2 20 1 25	
		3.2 Line type : (A	As followin Length L≦3.0 L≦2.5 	g drawing) Width W≦0.02 0.02 < W≦ 0.03 < W≦ 0.05 < W	2	2.5
04	Polarizer bubbles	If bubbles are vis judge using blac specifications, no to find, must che specify direction	k spot ot easy ock in	Size Φ $\Phi \leq 0.20$ $0.20 < \Phi \leq$ $0.50 < \Phi \leq$ $1.00 < \Phi$ Total Q T	≦1.00 2 0	

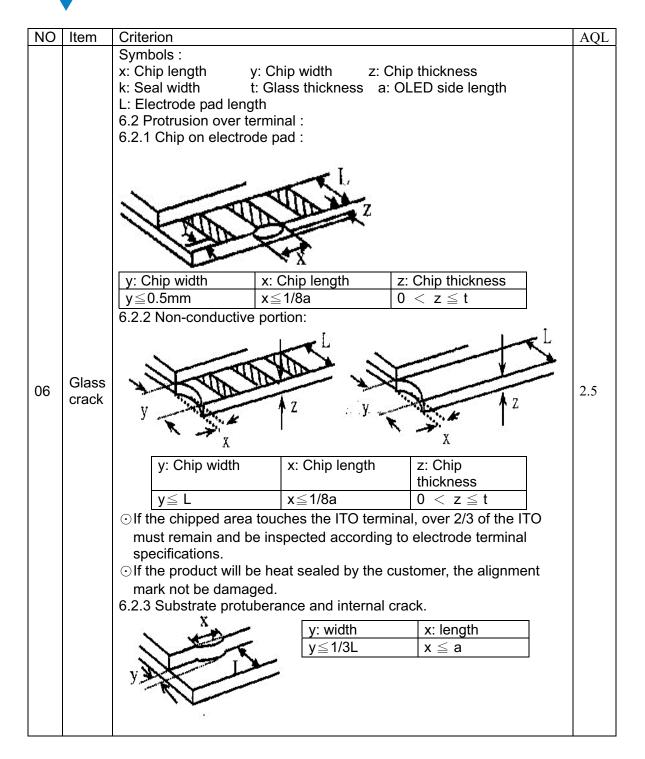
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NO	Item	Criterion			AQL
05	Scratches	Follow NO.3 OLED black spots, white spots, contamination			
			t: Glass thickness a	Chip thickness : OLED side length	
		6.1 General glass chi 6.1.1 Chip on panel s	ip : surface and crack betw x y k	ween panels:	
				y 1	
		z: Chip thickness	y: Chip width	x: Chip length	
06	Chipped	Z≦1/2t	Not over viewing area	x≦1/8a	2.5
	glass	$1/2t < z \leq 2t$	Not exceed 1/3k	x≦1/8a	
		6.1.2 Corner crack:	bre chips, x is total ler	igth of each chip.	
		z: Chip thickness	y: Chip width	x: Chip length	
		Z≦1/2t	Not over viewing area	x≦1/8a	
		$1/2t < z \leq 2t$	Not exceed 1/3k	x≦1/8a	
		\odot If there are 2 or mo	ore chips, x is the tota	l length of each chip.	

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NO	Item	Criterion	AQL
07	Cracked glass	The OLED with extensive crack is not acceptable.	2.5
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using OLED spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65
09	Bezel	9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.9.2 Bezel must comply with job specifications.	2.5 0.65
10	PCB、COB	 10.1 COB seal may not have pinholes larger than 0.2mm or contamination. 10.2 COB seal surface may not have pinholes through to the IC. 10.3 The height of the COB should not exceed the height indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places. 10.5 No oxidation or contamination PCB terminals. 10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts. 10.7 The jumper on the PCB should conform to the product characteristic chart. 10.8 If solder gets on bezel tab pads, OLED pad, zebra pad or screw hold pad, make sure it is smoothed down. 	 2.5 2.5 2.5 2.5 0.65 0.65 2.5
11	Soldering	 11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB. 	2.5 2.5 2.5 0.65



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NO	Item	Criterion	AQL
12	General appearance	 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.9 OLED pin loose or missing pins. 12.10 Product packaging must the same as specified on packaging specification sheet. 12.11 Product dimension and structure must conform to product specification sheet. 	2.5 0.65 2.5 2.5 2.5 2.5 2.5 0.65 0.65 0.65 0.65



Check Item	Classification	Criteria
No Display	Major	
Missing Line	Major	
Pixel Short	Major	
Darker Short	Major	
Wrong Display	Major	
Un-uniform B/A x 100% < 70% A/C x 100% < 70%	Major	A Normal B Dark Fixel C Light Fixel



11.Precautions in Use of OLED Modules

Modules

- (1)Avoid applying excessive shocks to module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of OLED display module.
- (3)Don't disassemble the OLED display module.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist OLED display module.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please store in anti-static electricity container and clean environment.
- (8)Use a "Screen Saver" to extend the lifetime. Do not show fixed information for a long time in the application.
- (9)Don't use fixed information in OLED panel for long time that will cause "screen burn" effect.
- (10)The manufacturer has the right to change the passive components, including R2and R3 adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (11) The manufacturer has the right to change the PCB Rev. (In order to satisfy supply stability, management optimization, and the best product performance..., under the premise of not affecting the electrical characteristics and external dimensions. The manufacturer has the right to modify the version.)
- 11.1. Handling Precautions
- (1) Since the display panel is made of glass, do not apply mechanical impacts such us dropping from a high position.
- (2) If the display panel is broken by some accident and the internal organic substance leaks out, be careful not to inhale or ingest the organic substance.
- (3) If pressure is applied to the display surface or its neighborhood of the OLED display module, the cell structure may be damaged, be careful not to apply pressure to these sections.
- (4) The polarizer covering the surface of the OLED display module is soft and easily scratched. Please be careful when handling the OLED display module.
- (5) When the surface of the polarizer of the OLED display module has soil, clean the surface. It takes advantage of by using following adhesion tape.

* Scotch Mending Tape No. 810 or an equivalent

Never try to breathe upon the soiled surface or wipe the surface using cloth containing solvent such as ethyl alcohol, since the surface of the polarizer will become cloudy.

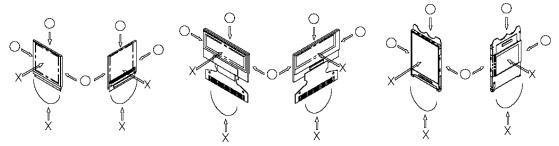
Also, pay attention that the following liquid and solvents can damage the polarizer:

- * Water
- * Ketone
- * Aromatic Solvents
- (6) Hold OLED display module very carefully when placing OLED display module into the system housing. Do not apply excessive stress or pressure to OLED display module. And, do not over bend the film with electrode pattern layouts.

These stresses will influence the display performance. Also, secure sufficient rigidity for the outer cases.



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(7) Do not apply stress to the LSI chips and the surrounding molded sections.

(8) Do not disassemble or modify the OLED display module.

(9) Do not apply input signals while the logic power is off.

(10) Pay sufficient attention to the working environments when handing OLED display modules to prevent occurrence of element breakage accidents by static electricity.

- * Be sure to make human body grounding when handling OLED display modules.
- * Be sure to ground tools to use or assembly such as soldering irons.
- * To suppress generation of static electricity, avoid carrying out assembly work under dry environments.
- * Protective film is being applied to the surface of the display panel of the OLED display module. Be careful since static electricity may be generated when removing the protective film.

(11) Protective film is applied to the surface of the display panel. Remove the protective film before assembly. If the OLED display module has been stored for a long period of time, residue adhesive material from the protective film may remain on the surface of the display panel after the film is removed. In such case, remove the residue material by the method introduced in the above Section 5.

(12) If electric current is applied when the OLED display module has moisture condensation or when it is placed under high humidity environments, the electrodes may corrode.

11.2. Storage Precautions

(1) When storing OLED display modules, put them in static electricity preventive bags avoiding exposure to direct sun light and fluorescent lamps. Avoid high temperature and high humidity environment or low temperature (less than 0°C) environments.

(We recommend storing these modules in the packaged state as they were shipped.) At that time, be careful not to let water drops adhere to the packages or bags or let condensation occur with them.

(2) If electric current is applied when condensation is present or when it is placed under high humidity environments, the electrodes may corrode.

11.3. Designing Precautions

(1) The absolute maximum ratings are the ratings which cannot be exceeded for OLED display module, and if these values are exceeded, panel damage may be happen.

(2) To prevent occurrence of malfunctioning by noise, pay attention to satisfy the VIL and VIH specifications and, at the same time, to make the signal line cable as short as possible.
 (2) We recommend you to install excess current preventive unit (fuers, etc.) to the power.

(3) We recommend you to install excess current preventive unit (fuses, etc.) to the power circuit (VDD). (Recommend value: 0.5A)

(4) Pay sufficient attention to avoid occurrence of mutual noise interference with the neighboring devices.

(5) For EMI, take necessary measures in the application equipment.

(6) When fastening the OLED display module, fasten the external plastic housing section.

(7) If power supply to the OLED display module is forcibly shut down by such errors as taking out the main battery while the OLED display panel is in operation, we cannot guarantee the quality of this OLED display module.



* Connection (contact) to any other potential than the above may lead to rupture of the IC.11.4.

Precautions when disposing of the OLED display modules

1) Request the qualified companies to handle industrial wastes when disposing of the OLED display modules. Or, when burning them, be sure to observe the environmental and hygienic laws and regulations.

11.5. Other Precautions

- (1) When an OLED display module is operated for a long time with a fixed pattern, the pattern may remain as an after image with slight contrast or brightness variation.
- Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.
- (2) To protect OLED display modules from performance drops by static electricity rapture, etc., do not touch the following sections whenever possible while handling the OLED display modules.
- * Pins and electrodes
- * Pattern layouts such as the TCP & FPC
- (3) With this OLED display module, the OLED driver is exposed. Generally, semiconductor elements change their characteristics when exposed to light, similar to the principle of the solar battery. Consequently, if this OLED driver is exposed to light, malfunctioning may occur.
- * Design the product and installation method so that the OLED driver may be shielded from light in actual usage.
- * Design the product and installation method so that the OLED driver may be shielded from light during the inspection processes.
- (4) Although this OLED display module stores the operational state data by the commands and the indication data, when excessive external noise, etc. enters into the module, the internal states may be changed. It therefore is necessary to take appropriate measures to suppress noise generation or to protect from influences of noise on the system design.
- (5) We recommend you to construct its software to make periodical refreshment of the operation statuses (re-setting of the commands and re-transference of the display data) to cope with catastrophic noise.
- (6)Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.
- (7)The manufacturer has the right to upgrade and modify the product function.



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